



Product Change Notification

Change Notification #: 116717 - 00
Change Title: Select Intel® SSD 660p Series Products, PCN 116717-00, Label, SA number update
Date of Publication: February 01, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	March 4, 2019
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Description of Change to the Customer:

The Intel® SSD 660p Series products listed below will undergo the following label update:

- SA# should be the same across MOQx of the same sku. SA#s for MOQ100 have been aligned to the corresponding SA# for MOQ1.

1.0TB Label Before:



1.0TB Label After:



512GB Label Before:



512GB Label After:



Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change SA	Post Change SA
Intel® SSD 660p Series Generic 100 Pack	SSDPEKNW010T8	999CG4	K42490-100	J93130-101
Intel® SSD 660p Series Generic 100 Pack	SSDPEKNW512G8	999CG3	K42482-100	J93121-101

PCN Revision History:

Date of Revision: February 1, 2019	Revision Number: 00	Reason: Originally Published PCN
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116717 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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